



# Product Change Notification

**Change Notification #:** 118147 - 01  
**Change Title:** MINOR CHANGE: Transport Media Country of Origin (COO) Label Value Change for Products Assembled in South Korea, PCN 118147-01, Transport Media, Standardize the Country of Origin (COO) value displayed on Labels, Reason for Revision: Updated Scope to Include Labels Printing the COO Value “Rep of Korea” in addition to “Korea”

**Date of Publication:** July 13, 2021

## Key Characteristics of the Change:

Transport Media

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	July 13, 2021
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## Description of Change to the Customer:

### Reason for Revision: Updated Scope to Include Labels Printing the COO Value “Rep of Korea” in addition to “Korea”

Intel is standardizing the naming convention for the Country of Origin (COO) value printed on labels used to transport products which are assembled in South Korea.

The COO values “Korea” or “Rep. of Korea” will no longer be used.

Where prior COO label values may have printed “Korea”, newly placed labels will print “South Korea”. Additionally, where prior COO label values may have printed “Rep. of Korea” newly placed labels will print “South Korea”.

Below are some examples of Intermediate Box Labels, Moisture Barrier Bag (MBB) Labels and Standard Shipping Labels showing the changes. They are not intended to be a complete representation of all labels impacted, only a few given to help customers understand the change.

Intermediate Box Label (IBOX) examples:

AS-IS



TO-BE



Intermediate Box Label (IBOX) examples:

AS-IS

( P ) CUST PROD :		( 1B ) BOX : <b>HF186407</b>
( V ) SUPPLIER : <b>04195</b>	<b>INTEL</b>	
		MAX REFLOW 260° C Temp 
(1P) IPN : <b>JHL2210</b>		LEVEL 3 HOURS 168
		BAG SEAL DATE 27 Sep 20
( S ) SPEC : <b>S LL37</b>	( 30P ) MM# : <b>944207</b>	
		( 9D ) DATE : <b>2037</b>
( 1T ) LOT : <b>X037TE09</b>	( Q ) QTY : <b>3000</b>	
		( 9D ) DATE :
( 1T ) LOT :	( Q ) QTY :	
e1		<b>ASSEMBLED IN REP. OF KOREA</b>

TO-BE

( P ) CUST PROD :		( 1B ) BOX : <b>HF186407</b>
( V ) SUPPLIER : <b>04195</b>	<b>INTEL</b>	
		MAX REFLOW 260° C Temp 
(1P) IPN : <b>JHL2210</b>		LEVEL 3 HOURS 168
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		( 9D ) DATE : <b>2037</b>
( 1T ) LOT : <b>X037TE09</b>	( Q ) QTY : <b>3000</b>	
		( 9D ) DATE :
( 1T ) LOT :	( Q ) QTY :	
e1		<b>ASSEMBLED IN SOUTH KOREA</b>

Moisture Barrier Bag (MBB) examples:

AS-IS



TO-BE



Moisture Barrier Bag (MBB) examples:

AS-IS

( P ) CUST PROD :	( 1B ) BOX :	
( V ) SUPPLIER : <b>04195</b> 	<b>INTEL</b>	MAX REFLOW 260° C Temp
(1P) IPN : <b>JHL2210</b> 	( 30P ) MM# : <b>944207</b> 	LEVEL 3 HOURS 168 BAG SEAL DATE 27 Sep 20 
( S ) SPEC : <b>S LL37</b> 	( Q ) QTY : <b>3000</b> 	( 9D ) DATE : <b>2037</b> 
( 1T ) LOT : <b>X037TE09</b> 	( Q ) QTY : 	( 9D ) DATE : 
( 1T ) LOT :		
e1		<b>ASSEMBLED IN REP. OF KOREA</b>

TO-BE

( P ) CUST PROD :	( 1B ) BOX :	
( V ) SUPPLIER : <b>04195</b> 	<b>INTEL</b>	MAX REFLOW 260° C Temp
(1P) IPN : <b>JHL2210</b> 	( 30P ) MM# : <b>944207</b> 	LEVEL 3 HOURS 168 BAG SEAL DATE 27 Sep 20 
( S ) SPEC : <b>S LL37</b> 	( Q ) QTY : <b>3000</b> 	( 9D ) DATE : <b>2037</b> 
( 1T ) LOT : <b>X037TE09</b> 	( Q ) QTY : 	( 9D ) DATE : 
( 1T ) LOT :		
e1		<b>ASSEMBLED IN SOUTH KOREA</b>

Shipping Label examples:

AS-IS



TO-BE



Shipping Label examples:

AS-IS

<b>FROM:</b> MIM-RCV PLOT 70, MUKIM 12 B. LEPAS 1RD PARK IV 11900 PNG MALAYSIA	<b>TO:</b> ZTE (H.K.) LIMITED C/O SHENZHEN CHANNELTON BONDED LOGISTICS CO LTD RM405 53 LINHAI AVENUE, NANSHAN DIST SHENZHEN, GD CHINA
e3	
(35) PKG #: 04195+0808542564  (IP) OPN: EV1340QI  (7Q) QUANTITY: 500 EA  (K) CUSTOMER PO#: KMA2007-022-138P-1  (P) CUSTOMER PRODUCT #: 003030400007  (Z) MISC: new label	PACKAGE COUNT: 1 OF 1 KG. LB. Gross Wt. 1.11 2.44
	(4L) COO: REP. OF KOREA  (9D) DATE CODE: 2028  (V) SUPPLIER ID: 04195 

TO-BE

<b>FROM:</b> MIM-RCV PLOT 70, MUKIM 12 B. LEPAS 1RD PARK IV 11900 PNG MALAYSIA	<b>TO:</b> ZTE (H.K.) LIMITED C/O SHENZHEN CHANNELTON BONDED LOGISTICS CO LTD RM405 53 LINHAI AVENUE, NANSHAN DIST SHENZHEN, GD CHINA
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(35) PKG #: 04195+0808542564  (IP) OPN: EV1340QI  (7Q) QUANTITY: 500 EA  (K) CUSTOMER PO#: KMA2007-022-138P-1  (P) CUSTOMER PRODUCT #: 003030400007  (Z) MISC: new label	PACKAGE COUNT: 1 OF 1 KG. LB. Gross Wt. 1.11 2.44
	(4L) COO: SOUTH KOREA  (9D) DATE CODE: 2028  (V) SUPPLIER ID: 04195 

All pictures for example only.

## Customer Impact of Change and Recommended Action:

Intel considers this change a MINOR CHANGE. There is no change to the product form, fit, function, quality or reliability. This change only impacts the value displayed on the transport or shipping of products assembled in South Korea.

The type of shipment media impacted by this change are as follows:

- Any product shipped in a Desiccant bag
- Any product shipped in an Intermediate Box (I-Box)
- Any product Shipped in a Shipping Box

This change will apply only to new labels being printed going forward. Intel will not be relabeling any existing products which have already been packaged, labeled and shelved.

It is possible for customers to see a mixture of inventory where some have the newer standardized value while others have the older represented country value until inventory with labels showing the older country value are depleted.

Please see your Intel Representative with any questions or concerns regarding the communication shared within this product change notification.

## Products Affected / Intel Ordering Codes:

Due to the size of the impacted product list, the products will not be listed within this customer notification but are attached. Please refer to the attached excel list of products per the MM#, Product Code or Spec Code.

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
May 16, 2021	00	Originally Published PCN
July 13, 2021	01	Updated Scope to Include Labels Printing the COO Value "Rep of Korea" in addition to "Korea"





# Product Change Notification

## 118147 - 01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

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**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

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